



GLASS PASSIVATED RECTIFIERS

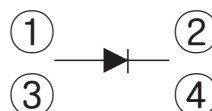
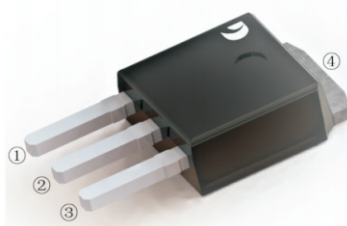
Reverse Voltage - 1200 V

Forward Current - 12 A

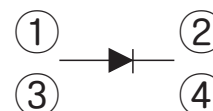
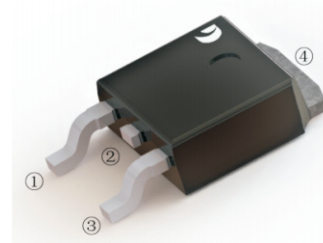
FEATURES

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any

TO-251(I-PAK)



TO-252(D-PAK)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	TO-251	G1012VY	Units
	TO-252	G1012DY	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1200	V
Maximum RMS voltage	V_{RMS}	840	V
Maximum DC Blocking Voltage	V_{DC}	1200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	10	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	180	A
Max Instantaneous Forward Voltage at 10 A DC	V_F	1.1	V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 125^\circ\text{C}$	I_R	5 500	uA
Typical Junction Capacitance ⁽¹⁾	C_j	150	pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	50	°C/W
Operating Junction Temperature Range	T_j	-55 ~ +150	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 10cmX10cmX1mm copper pad areas.



Fig.1 Typical Forward Current Derating Curve

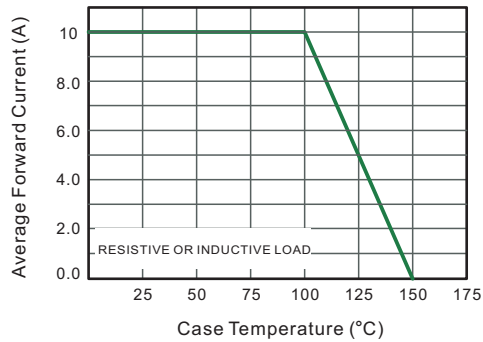


Fig.2 Typical Instantaneous Reverse Characteristics

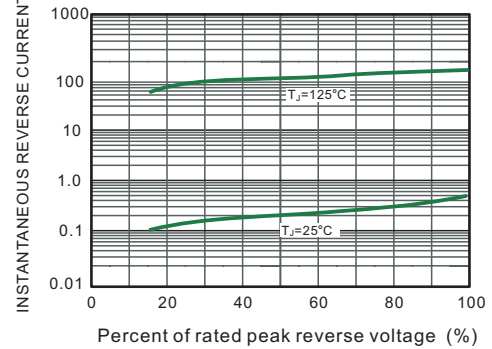


Fig.3 Typical Forward Characteristic

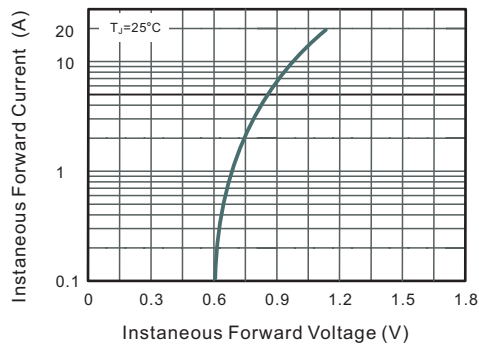


Fig.4 Typical Junction Capacitance

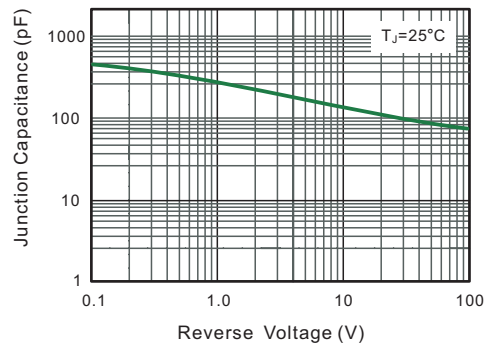


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

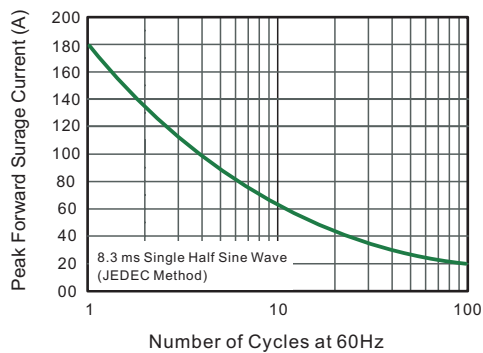
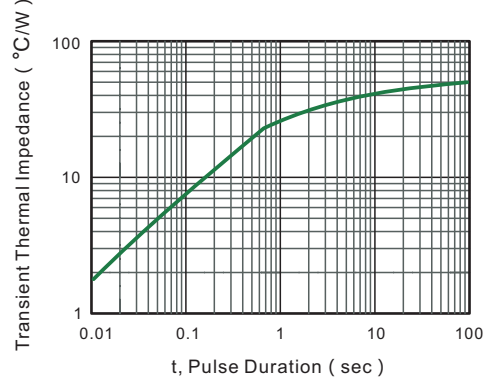
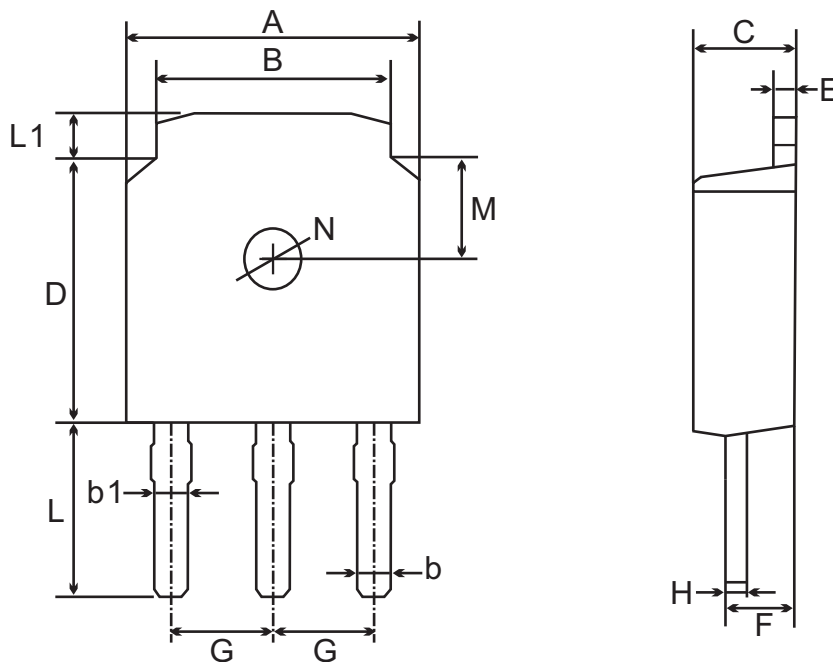


Fig.6- Typical Transient Thermal Impedance





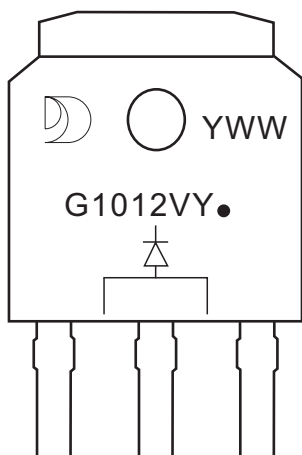
TO-251(I-PAK) Package Outline Dimensions



TO-251(I-PAK) mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	6.7	5.5	0.86	0.9	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	4.3	1.2	1.8 TYPICAL	1.3 TYPICAL
	min	6.3	5.1	0.66	0.76	2.1	5.9	0.4	1.3		0.45	3.9	0.8		
mil	max	264	217	34	35	98	248	24	71	90 TYPICAL	22	169	47	71 TYPICAL	51 TYPICAL
	min	248	201	26	30	83	232	16	51		18	154	31		

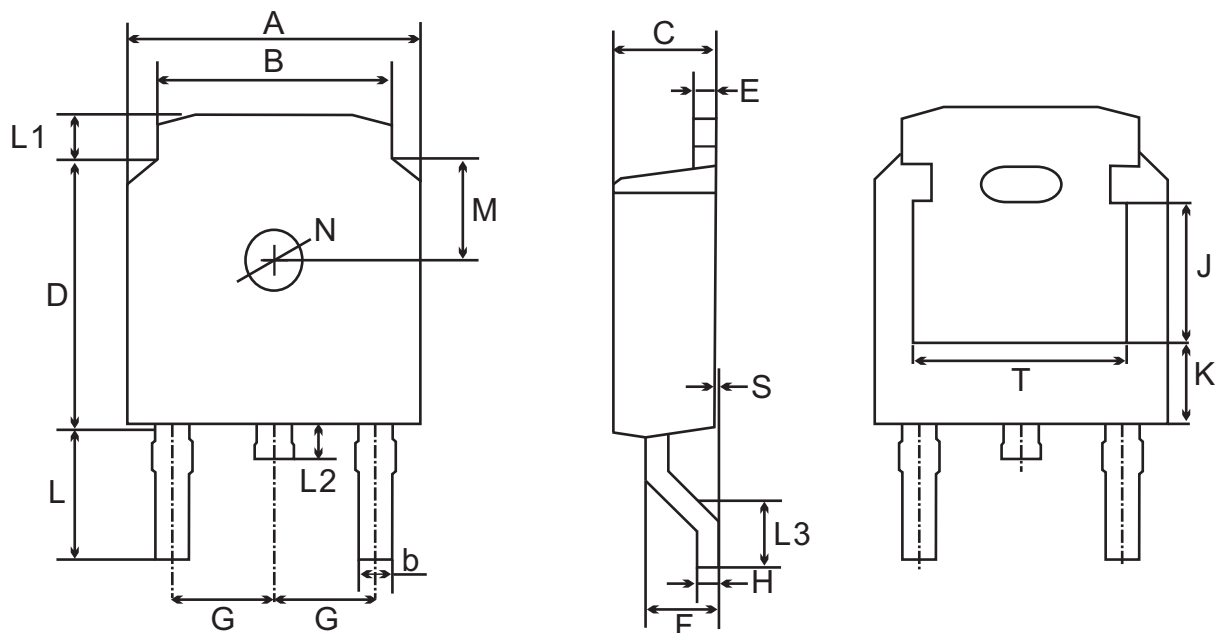
MARKING DIAGRAM



YWW: Date Code
Y:Years(0~9)
WW:Week
G1012VY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



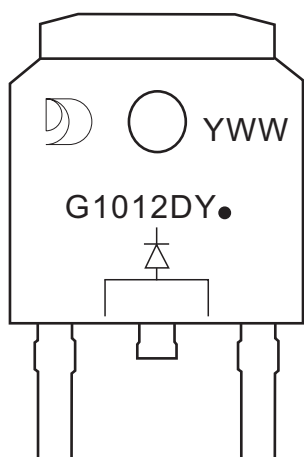
TO-252(D-PAK) Package Outline Dimensions



TO-252(D-PAK) mechanical data

UNIT	A	B	b	C	D	E	F	G	H	L	L1	L2	L3	S	M	N	J	K	T	
mm	max	6.7	5.5	0.86	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL	1.3	3.16	1.80	4.83
	min	6.3	5.1	0.66	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.40	0.0		ref.	ref.	ref.	
mil	max	264	217	34	98	248	24	71	90 TYPICAL	22	122	47	39	69	4	71 TYPICAL	51	124	71	190
	min	248	201	26	83	232	16	51		18	106	31	24	55	0		ref.	ref.	ref.	

MARKING DIAGRAM



YWW: Date Code
Y: Years(0~9)
WW: Week
G1012DY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



Important Notice and Disclaimer

Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Jingdao Microelectronics assume any liability for application assistance or customer product design.

Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics.

Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.